

FDP7N50U/FDPF7N50U

500V N-Channel MOSFET

Features

- 5A, 500V, $R_{DS(on)} = 1.5\Omega @V_{GS} = 10 V$
- Low gate charge (typical 12.8 nC)
- Low C_{rss} (typical 9 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

October 2009

UniF

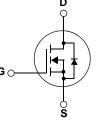
TΜ

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



GDS





Absolute Maximum Ratings

Symbol		Parameter		FDP7N50U	FDPF7N50U	Unit
V _{DSS}	Drain-Source Voltage		500		V	
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C		5 3.0	5 * 3.0 *	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	20	20 *	А
V _{GSS}	Gate-Source voltage)		±30		V
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	125		mJ
I _{AR}	Avalanche Current		(Note 1)	5		А
E _{AR}	Repetitive Avalanche Energy (Not		(Note 1)	8.9		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	20		V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		89 0.71	31.3 0.25	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300		°C	

Thermal Characteristics

Symbol	Parameter	FDP7N50U	FDPF7N50U	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.4	4.0	°C/W
R_{\thetaCS}	Thermal Resistance, Case-to-Sink Typ.	0.5		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

1

Ð
P7
ž
ö
L F
Ë
PF
Z
150
Č
50
Š
Ì
Ь.
ha
anne
lel I
Σ
MOSF
Ĩ
Ч

-

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP7N50U	FDP7N50U	TO-220			50
FDPF7N50U	FDPF7N50U	TO-220F			50

Electrical Characteristics $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
Off Charac	teristics				Į	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250 \mu A$	500			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current $V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_{C} = 125^{\circ}C$				25 250	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
On Charac	teristics				1	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 2.5A		1.2	1.5	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40V, I_D = 2.5A$ (Note 4)		2.5		S
Dynamic C	haracteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$		720	940	pF
C _{oss}	Output Capacitance	f = 1.0MHz		95	190	pF
C _{rss}	Reverse Transfer Capacitance			9	13.5	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250V, I _D = 5A		6	20	ns
t _r	Turn-On Rise Time	$R_{G} = 25\Omega$		55	120	ns
t _{d(off)}	Turn-Off Delay Time			25	60	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		35	80	ns
Qg	Total Gate Charge	V _{DS} = 400V, I _D = 5A		12.8	16.6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		3.7		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		5.8		nC
Drain-Sour	ce Diode Characteristics and Maximum	n Ratings			ļ	I
Is Maximum Continuous Drain-Source Diode Forward Current					5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				20	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 5A			1.6	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_{S} = 5A$		40		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100A/μs (Note 4)		0.04		μC

NOTES:

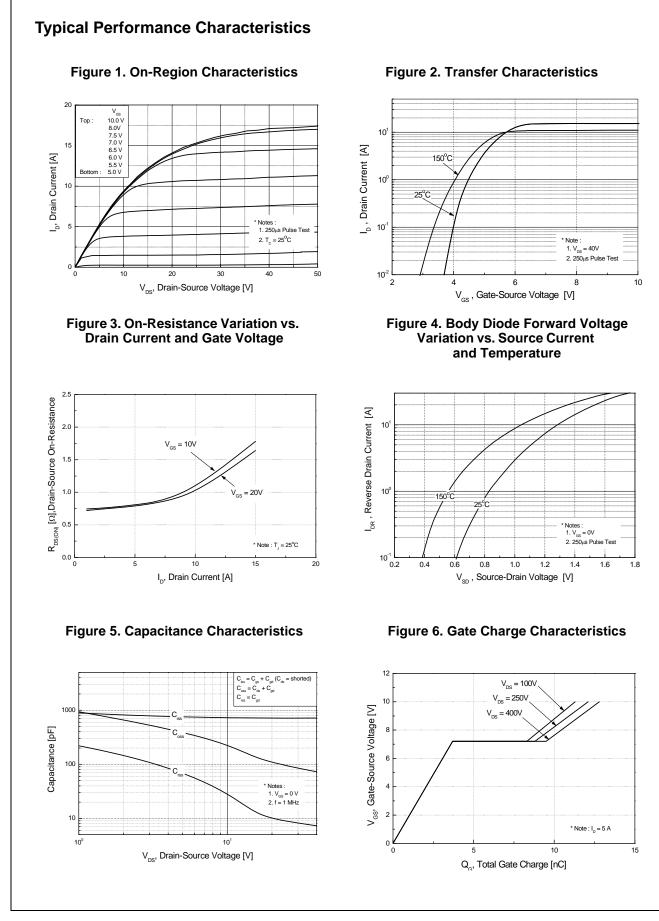
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 5A, V_{DD} = 50V, L=10mH, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

3. $I_{SD} \leq 5A, \, di/dt \leq 200A/\mu s, \, V_{DD} \leq BV_{DSS}, \, Starting \, T_J$ = $25^{\circ}C$

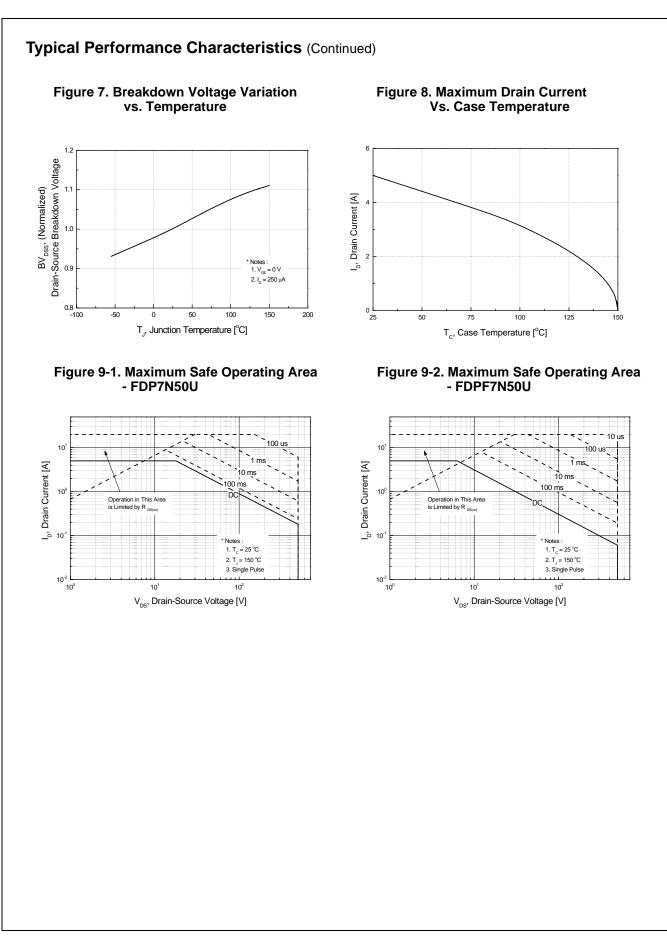
4. Pulse Test: Pulse width $\leq 300 \mu s, \, Duty \, Cycle \leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics



FDP7N50U/FDPF7N50U REV. B1

FDP7N50U/FDPF7N50U 500V N-Channel MOSFET



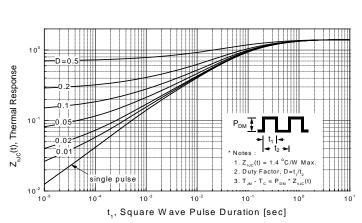
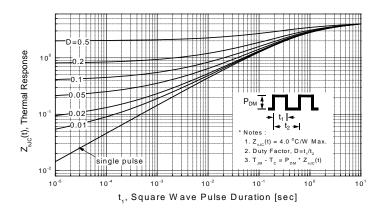
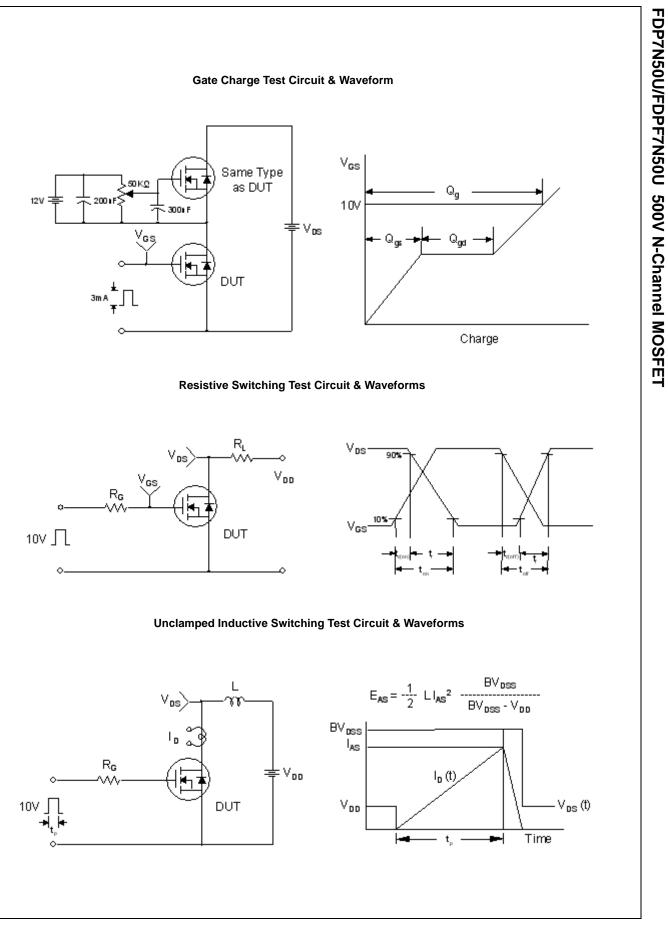


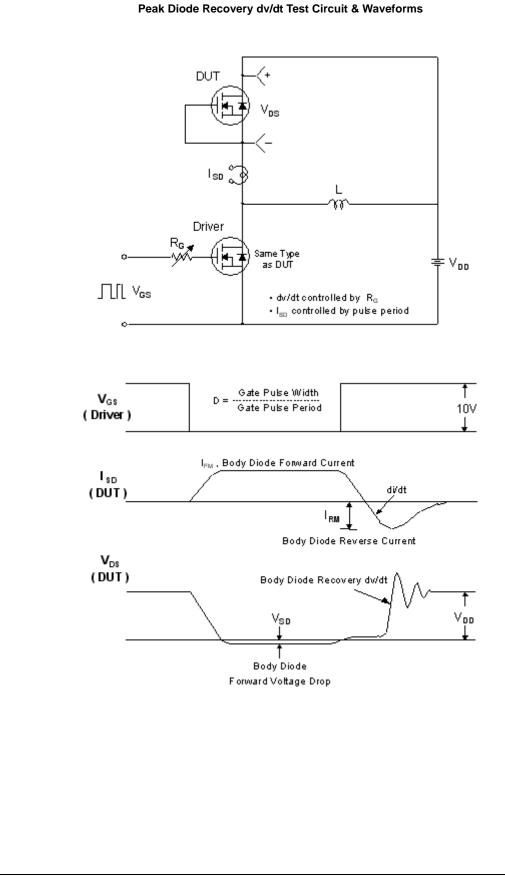
Figure 10-1. Transient Thermal Response Curve - FDP7N50U

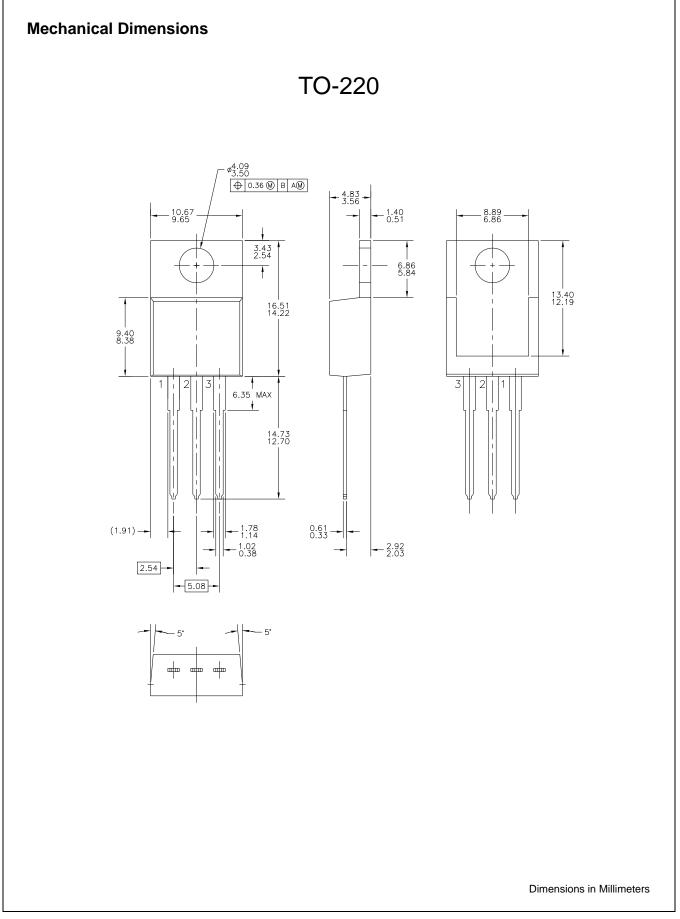
Figure 10-2. Transient Thermal Response Curve - FDPF7N50U

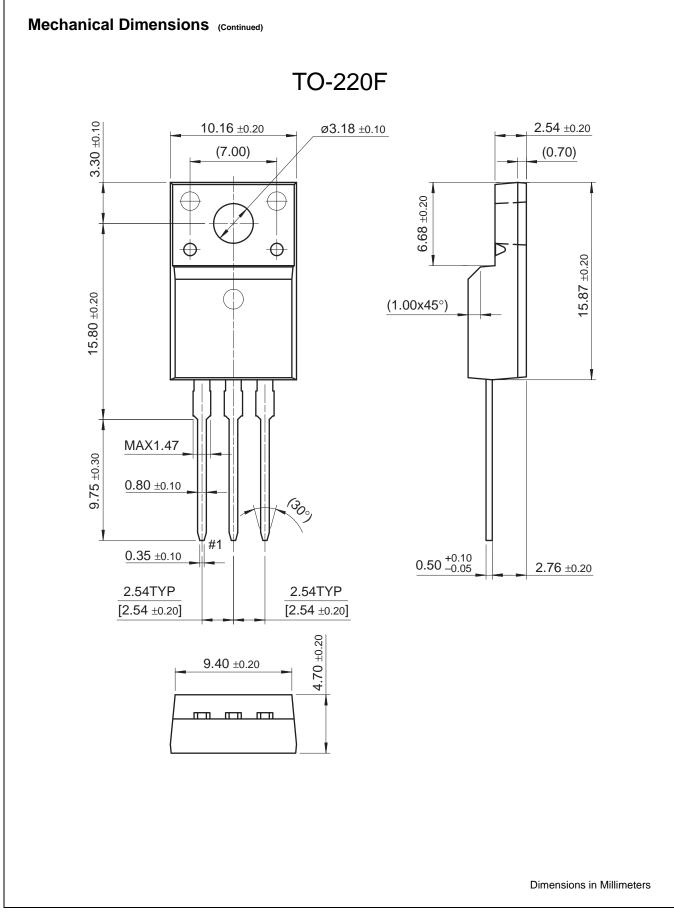




FDP7N50U/FDPF7N50U REV. B1









SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	FPS™	PowerTrench [®]	The Power Franchise [®]
Auto-SPM™	F-PFS™	PowerXS™	
Build it Now™	FRFET®	Programmable Active Droop™	pewer [®]
CorePLUS™	Global Power Resource SM	QFET®	Iranchise
CorePOWER™	Green FPS™	QS™	TinyBoost™
CROSSVOLT™	Green FPS™ e-Series™	Quiet Series™	TinyBuck™
CTL™	Gmax™	RapidConfigure™	TinyCalc™
Current Transfer Logic™	GTO™		TinyLogic®
EcoSPARK [®]	IntelliMAX™		TINYOPTO™
EfficentMax™	ISOPLANAR™	Saving our world, 1mW /W /kW at a time™	TinyPower™
EZSWITCH™*	MegaBuck™	SmartMax™	TinyPWM™
T11	MICROCOUPLER™	SMART START™	TinyWire™
-7	MicroFET TM	SPM®	TriFault Detect™
	MicroPak™	STEALTH™	TRUECURRENT™*
+ "	MillerDrive™	SuperFET™	
Fairchild [®]	MotionMax™	SuperSOT™-3	SerDes
Fairchild Semiconductor®	Motion-SPM™	SuperSOT™-6	UHC®
FACT Quiet Series™	OPTOLOGIC®	SuperSOT™-8	Ultra FRFET™
FACT®	OPTOPLANAR®	SupreMOS™	UniFET™
FAST®	®	SyncFET™	VCXTM
FastvCore™		Sync-Lock™	VisualMax™
FETBench™	<u>U</u>		XS™
FlashWriter [®] *	PDP SPM™	SYSTEM ®*	
	Power-SPM [™]	GENERAL	
*Trademarks of System General Cor	poration, used under license by Fairchild	Semiconductor	
riducinanto or cysterri deneral cor	poration, asca anaci license by r alicilia	Comiconductor.	

DISCLAIMER FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS. SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's guality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.